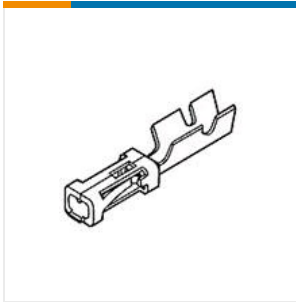




CONNECTORS

WIRE-TO-BOARD CONNECTOR CONTACTS



✓ Active

↓ **PRODUCT DRAWING**
English

↓ **3D PDF**

TE CONNECTIVITY (TE)

MOD-4 REC.CONT.SCP.

AMPMODU | AMPMODU IV/V

141708-1

TE Internal Number: 141708-1

Always EU RoHS/ELV Compliant

Contact Type **Socket**

Wire/Cable Size (AWG) **26**

Wire/Cable Size (mm²) **.12 – .15**

Contact Mating Area Plating Material **Gold**

Packaging Method **Loose Piece**



Product Drawings

AMP MODU MIN CONTACT

PDF (**TIFF AVAILABLE**)

English

AMP MODU MIN CONTACT

PDF (**TIFF AVAILABLE**)

English

CAD Files

Customer View Model

2D_DXF.ZIP

English

3D PDF

PDF

3D

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP

English

Please review product documents or [contact us](#) for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features	With Insulation Support	Yes
	Wire/Cable Type	Discrete Wire
	Applied Pressure	Intermediate
	Product Type	Contact
	Applies To	Wire/Cable

Contact Features	Contact Type	Socket
	Contact Mating Area Plating Material	Gold
	Contact Mating Area Plating Thickness (µin)	30
	Contact Base Material	Phosphor Bronze

Termination Features	Termination Method to Wire/Cable	Crimp
	Crimp Area Plating Material	Tin

Dimensions	Wire/Cable Size (AWG)	26
	Wire/Cable Size (mm ²)	.12 – .15
	Insulation Diameter	1.4 mm [.055 in]

Packaging Features	Packaging Method	Loose Piece
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Other	Comment	For 0.63 mm "Round" Post and 0.63 x 0.63 mm "Square" Post., Reduced crimp width at 0.14 mm². Please contact AMP.
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Product Compliance [Statement of Compliance](#)
PDF

[VIEW ALL PRODUCT COMPLIANCE](#)

